P/N:WTLTO39433 TO39 433.92MHz

Win-win To Long

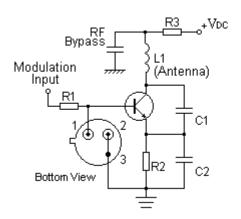
Features

- 1-port Resonator
- Metal Case for TO-39
- RoHS compatible
- Package Code TO-39
- Electrostatic Sensitive Device(ESD)

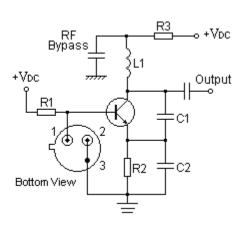


Application

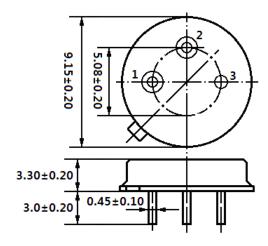
Typical Low-Power Transmitter Application



Typical Local Oscillator Application



Package Dimensions (TO-39)



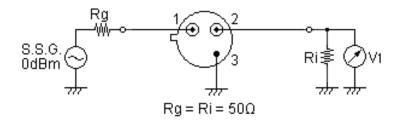
Pin Configuration

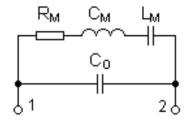
1	Input/ Output		
2	Output/ Input		
3	Ground		



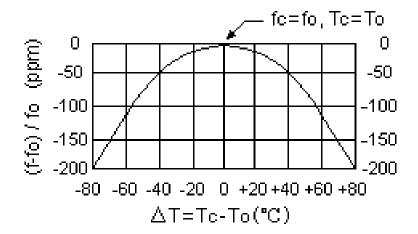
Test Circuit

Equivalent LC Model





Temperature Characteristics



The curve shown above accounts for resonator contribution only and does not include LC component temperature contributions.

P/N:WTLTO39433 TO39 433.92MHz



Performance

Maximum Rating

Item		Value	Unit
DC Voltage	V _{DC}	±30	V
Operation Temperature	Т	-40 ~ +85	$^{\circ}$
Storage Temperature	T _{stg}	-55 ~ +125	${\mathbb C}$
RF Power Dissipation	Р	10	dBm

Electronic Characteristics

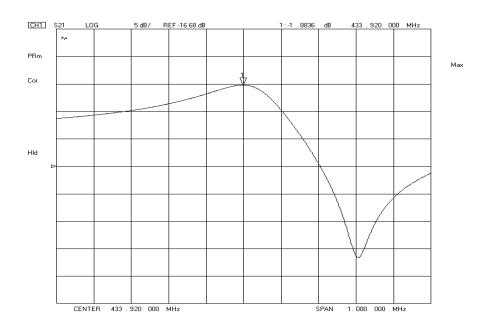
Test Temperature: $25^{\circ}\text{C} \pm 2^{\circ}\text{C}$

Terminating source impedance: 50Ω Terminating load impedance: 50Ω

Item			Minimum	Typical	Maximum	Unit
Center	Absolute Frequency	fc		433.92		MHz
Frequency	Tolerance from433.92MHz	△fc		±75		KHz
Insertion Loss(min)		IL		1.9	2.2	dB
Quality Factor	Unloaded Q	Q _U		13173		
	50Ω Loaded Q	QL		2167		
Temperature Stability	Turnover Temperature	T ₀	25	40	55	${\mathbb C}$
	Frequency Temperature Coefficient	FTC		0.032		ppm/℃
Frequency Aging Absolute Value during the First Year		f _A		≤10		ppm/yr
DC Insulation Resistance between Any Two Pins			1.0			МΩ
RF Equivalent RLC Model	Motional Resistance	R _M		20	29	Ω
	Motional Inductance	L _M		95.2		μΗ
	Motional Capacitance	См		1.42		fF
	Static Capacitance	C ₀	1.75	2.05	2.35	pF



Frequency Response

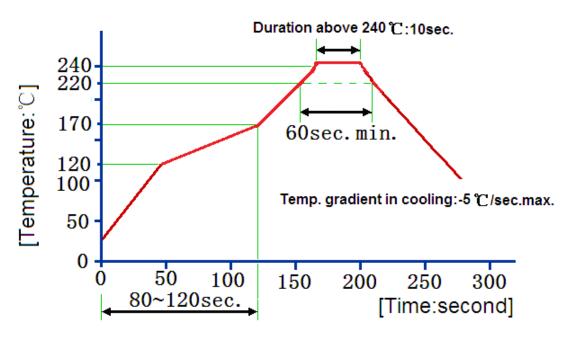


Reliability (The SAW components shall remain electrical performance after tests)

No.	Test item	Test condition
1	Temperature	(1) Temperature: 85℃±2℃,Duration: 250h,Recovery time: 2h±0.5h
Storage	(2) Temperature: –40℃±3℃,Duration: 250h ,Recovery time: 2h±0.5h	
2	Humidity Test	Conditions: 60℃±2℃,90~95% RH
		Heat cycle conditions: TA=-40℃±3℃, TB=85℃±2℃, t1=t2=30min, Switch
3 Thermal Sho	i nermai Snock	time: ≤3min , Cycle time: 100 times , Recovery time : 2h±0.5h.
4 Vibration Fa	Vibration Estique	Frequency of vibration: 10~55Hz Amplitude:1.5mm
	vibration Fatigue	Directions: X,Y and Z Duration: 2h
5	Drop Test	Cycle time: 10 times Height: 1.0m
	Oalden Abilite Teet	Temperature: 245℃±5℃ Duration: 3.0s5.0s
6	Solder Ability Test	Depth: DIP2/3 , SMD1/5
7		(1)Thickness of PCB:1mm , Solder condition: 260℃±5℃ , Duration: 10±1s
	Resistance to Soldering Heat	(2)Temperature of Soldering Iron: 350℃±10℃,Duration: 3~4s,
		Recovery time : 2 ± 0.5h



Recommended Reflow Soldering Diagram



Reflow cycles:3 cycles max.

Notes

- 1. As a result of the particularity of inner structure of SAW products, it easy to be breakdown by electrostatic, so we should pay attention to ESD protect in the test.
- 2. Static voltage between signal load and ground may cause deterioration and destruction of the component. Please avoid static voltage.
- 3. Ultrasonic cleaning may cause deterioration and destruction of the component. Please avoid ultrasonic cleaning.
- 4. Only leads of component may be soldered. Please avoid soldering another part of component.
- 5. There is a close relationship between the device's performance and matching network. The specifications of this device are based on the test circuit shown above. L and C values may change depending on board layout. Values shown are intended as a guide only.